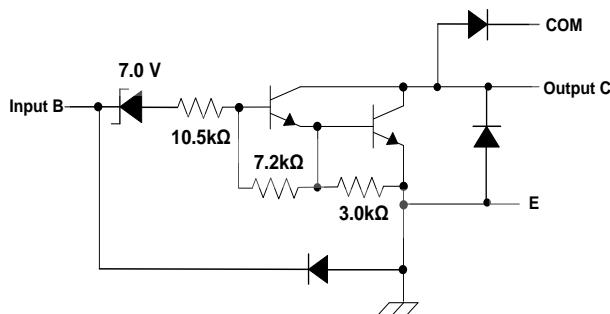


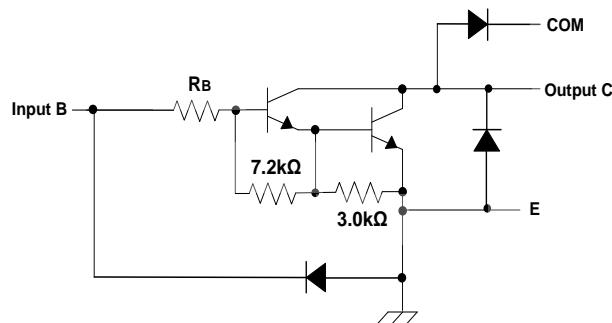
Pin Descriptions

Pin Number SO-16/PDIP-16	Pin Name	Function
1	1B	Input Pair 1
2	2B	Input Pair 2
3	3B	Input Pair 3
4	4B	Input Pair 4
5	5B	Input Pair 5
6	6B	Input Pair 6
7	7B	Input Pair 7
8	E	Common Emitter (Ground)
9	COM	Common Clamp Diodes
10	7C	Output Pair 7
11	6C	Output Pair 6
12	5C	Output Pair 5
13	4C	Output Pair 4
14	3C	Output Pair 3
15	2C	Output Pair 2
16	1C	Output Pair 1

Functional Block Diagram



ULN2002A



ULN2003A: $R_B = 2.7\text{k}$
ULN2004A: $R_B = 10.5\text{k}$

ULN2003A, ULN2004A

Absolute Maximum Ratings (Note 4) (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Symbol	Parameter	Rating	Unit
V_{CC}	Collector to Emitter Voltage	50	V
V_R	Clamp Diode Reverse Voltage (Note 5)	50	V
V_I	Input Voltage (Note 5)	30	V
I_{CP}	Peak Collector Current	500	mA
I_{OK}	Output Clamp Current	500	mA
I_{TE}	Total Emitter Current	-2.5	A
θ_{JA}	Thermal Resistance Junction-to-Ambient (Note 6)	SO-16 PDIP-16	63.0 50.0
		SO-16 PDIP-16	12.0 15.0
T_J	Junction Temperature	+150	$^\circ\text{C}$
T_{STG}	Storage Temperature	-65 to +150	$^\circ\text{C}$

- Notes:
- 4. Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only. Functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
 - 5. All voltage values are with respect to the emitter/substrate terminal E, unless otherwise noted.
 - 6. Maximum power dissipation is a function of $T_J(\text{max})$, θ_{JA} and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(\text{max}) - T_A)/\theta_{JA}$. Operating at the absolute maximum T_J of $+150^\circ\text{C}$ can affect reliability.
 - 7. Maximum power dissipation is a function of $T_J(\text{max})$, θ_{JC} and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(\text{max}) - T_C)/\theta_{JC}$. Operating at the absolute maximum T_J of $+150^\circ\text{C}$ can affect reliability.

Recommended Operating Conditions

Symbol	Parameter	Min	Max	Unit
V_{CC}	Collector to Emitter Voltage	—	50	V
T_A	Operating Ambient Temperature	-40	+105	$^\circ\text{C}$

Electrical Characteristics (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

ULN2002A							
Symbol	Parameter	Test Figure	Test Conditions	Min	Typ	Max	Unit
$V_{I(ON)}$	On State Input Voltage	6	$V_{CE} = 2\text{V}$, $I_C = 300\text{mA}$	—	—	13	V
$V_{CE(SAT)}$	Collector Emitter Saturation Voltage	5	$I_I = 250\mu\text{A}$, $I_C = 100\text{mA}$	—	0.9	1.1	V
			$I_I = 350\mu\text{A}$, $I_C = 200\text{mA}$	—	1	1.3	
			$I_I = 500\mu\text{A}$, $I_C = 350\text{mA}$	—	1.2	1.6	
V_F	Clamp Forward Voltage	8	$I_F = 350\text{mA}$	—	1.7	2	V
I_{CEx}	Collector Cut-off Current	1	$V_{CE} = 50\text{V}$, $I_I = 0$	—	—	50	μA
		2	$V_{CE} = 50\text{V}$, $T_A = +105^\circ\text{C}$	$I_I = 0$	—	100	
			$V_I = 6\text{V}$	—	—	500	
$I_{I(OFF)}$	Off State Input Current	3	$V_{CE} = 50\text{V}$, $I_C = 500\mu\text{A}$	50	65	—	μA
I_I	Input Current	4	$V_I = 17\text{V}$	—	0.82	1.25	mA
I_R	Clamp Reverse Current	7	$V_R = 50\text{V}$	$T_A = +105^\circ\text{C}$	—	100	μA
				—	—	50	
C_I	Input Capacitance	—	$V_I = 0$, $f = 1\text{MHz}$	—	—	25	pF

Electrical Characteristics (Cont.) (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

ULN2003A

Parameter		Test Figure	Test Conditions		Min	Typ	Max	Unit
$V_{I(ON)}$	On State Input Voltage	6	$V_{CE} = 2\text{V}$	$I_C = 200\text{mA}$	—	—	2.4	V
				$I_C = 250\text{mA}$	—	—	2.7	
				$I_C = 300\text{mA}$	—	—	3	
$V_{CE(SAT)}$	Collector Emitter Saturation Voltage	5		$I_I = 250\mu\text{A}, I_C = 100\text{mA}$	—	0.9	1.1	V
				$I_I = 350\mu\text{A}, I_C = 200\text{mA}$	—	1	1.3	
				$I_I = 500\mu\text{A}, I_C = 350\text{mA}$	—	1.2	1.6	
V_F	Clamp Forward Voltage	8	$I_F = 350\text{mA}$		—	1.7	2	V
I_{CEX}	Collector Cut-off Current	1	$V_{CE} = 50\text{V}, I_I = 0$		—	—	50	μA
		2	$V_{CE} = 50\text{V}, T_A = +105^\circ\text{C}$	$I_I = 0$	—	—	100	
$I_{I(OFF)}$	Off State Input Current	3	$V_{CE} = 50\text{V}, I_C = 500\mu\text{A}$		50	65	—	μA
I_I	Input Current	4	$V_I = 3.85\text{V}$		—	0.93	1.35	mA
I_R	Clamp Reverse Current	7	$V_R = 50\text{V}$	$T_A = +105^\circ\text{C}$	—	—	100	μA
				—	—	—	50	
C_I	Input Capacitance	—	$V_I = 0, f = 1\text{MHz}$		—	15	25	pF

ULN2004A

Parameter		Test Figure	Test Conditions		Min	Typ	Max	Unit
$V_{I(ON)}$	On State Input Voltage	6	$V_{CE} = 2\text{V}$	$I_C = 125\text{mA}$	—	—	5	V
				$I_C = 200\text{mA}$	—	—	6	
				$I_C = 275\text{mA}$	—	—	7	
				$I_C = 350\text{mA}$	—	—	8	
$V_{CE(SAT)}$	Collector Emitter Saturation Voltage	5		$I_I = 250\mu\text{A}, I_C = 100\text{mA}$	—	0.9	1.1	V
				$I_I = 350\mu\text{A}, I_C = 200\text{mA}$	—	1	1.3	
				$I_I = 500\mu\text{A}, I_C = 350\text{mA}$	—	1.2	1.6	
V_F	Clamp Forward Voltage	8	$I_F = 350\text{mA}$		—	1.7	2	V
I_{CEX}	Collector Cut-off Current	1	$V_{CE} = 50\text{V}, I_I = 0$		—	—	50	μA
		2	$V_{CE} = 50\text{V}, T_A = +105^\circ\text{C}$	$I_I = 0$	—	—	100	
				$V_I = 6\text{V}$	—	—	500	
$I_{I(OFF)}$	Off State Input Current	3	$V_{CE} = 50\text{V}, I_C = 500\mu\text{A}$		50	65	—	μA
I_I	Input Current	4	$V_I = 5\text{V}$		—	0.35	0.5	mA
I_R	Clamp Reverse Current	7	$V_R = 50\text{V}$	$T_A = +105^\circ\text{C}$	—	—	100	μA
				—	—	—	50	
C_I	Input Capacitance	—	$V_I = 0, f = 1\text{MHz}$		—	15	25	pF

Electrical Characteristics (Cont.) (@ $T_A = -40^\circ\text{C}$ to $+105^\circ\text{C}$, unless otherwise specified.)

ULN2003A

Parameter		Test Figure	Test Conditions		Min	Typ	Max	Unit
$V_{I(\text{ON})}$	On State Input Voltage	6	$V_{CE} = 2\text{V}$	$I_C = 200\text{mA}$	—	—	2.7	V
				$I_C = 250\text{mA}$	—	—	2.9	
				$I_C = 300\text{mA}$	—	—	3	
$V_{CE(\text{SAT})}$	Collector Emitter Saturation Voltage	5		$I_I = 250\mu\text{A}, I_C = 100\text{mA}$	—	0.9	1.2	V
				$I_I = 350\mu\text{A}, I_C = 200\text{mA}$	—	1	1.4	
				$I_I = 500\mu\text{A}, I_C = 350\text{mA}$	—	1.2	1.7	
V_F	Clamp Forward Voltage	8	$I_F = 350\text{mA}$		—	1.7	2.2	V
I_{CEX}	Collector Cut-off Current	1	$V_{CE} = 50\text{V}, I_I = 0$		—	—	100	μA
$I_{I(\text{OFF})}$	Off State Input Current	3	$V_{CE} = 50\text{V}, I_C = 500\mu\text{A}$		30	65	—	μA
I_I	Input Current	4	$V_I = 3.85\text{V}$		—	0.93	1.35	mA
I_R	Clamp Reverse Current	7	$V_R = 50\text{V}$		—	—	100	μA
C_I	Input Capacitance	—	$V_I = 0, f = 1\text{MHz}$		—	15	25	pF

Switching Characteristics (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

ULN2002A, ULN2003A, ULN2004A

Parameter		Test figure	Min	Typ	Max	Unit
t_{PLH}	Propagation Delay Time, Low to High Level Output	9	—	0.25	1	μs
t_{PHL}	Propagation Delay Time, High to Low Level Output	9	—	0.25	1	μs
V_{OH}	High Level Output Voltage after Switching	9 ($V_S = 50\text{V}, I_O = 300\text{mA}$)	V_S-20	—	—	mV

Switching Characteristics (@ $T_A = -40$ to $+105^\circ\text{C}$, unless otherwise specified.)

ULN2003A

Parameter		Test figure	Min	Typ	Max	Unit
t_{PLH}	Propagation Delay Time, Low to High Level Output	9	—	1	10	μs
t_{PHL}	Propagation Delay Time, High to Low Level Output	9	—	1	10	μs
V_{OH}	High Level Output Voltage after Switching	9 ($V_S = 50\text{V}, I_O = 300\text{mA}$)	V_S-50	—	—	mV

Parameter Measurement Circuits

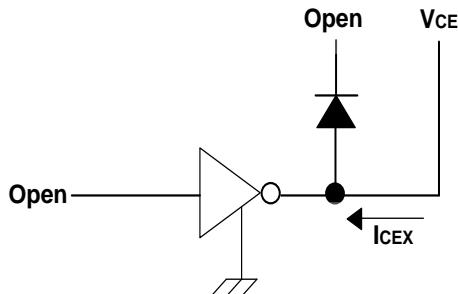


Fig.1 I_{CEx} Test Circuit

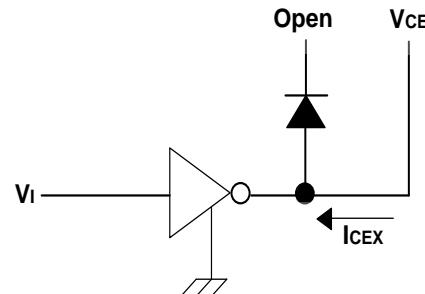


Fig.2 I_{CEx} Test Circuit

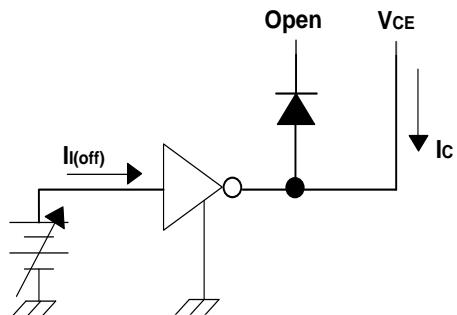


Fig.3 $I_{i(off)}$ Test Circuit

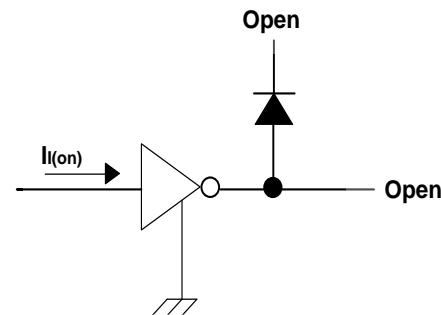


Fig.4 I_i Test Circuit

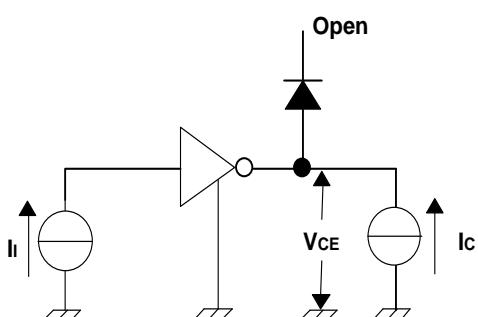


Fig.5 h_{FE} , $V_{CE(sat)}$ Test Circuit

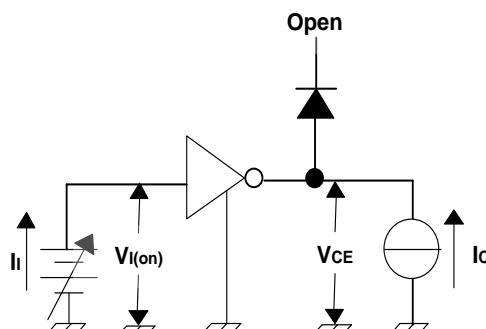


Fig.6 $V_{I(on)}$ Test Circuit

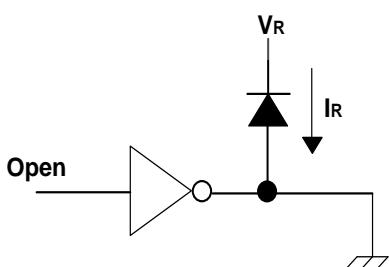


Fig.7 I_R Test Circuit

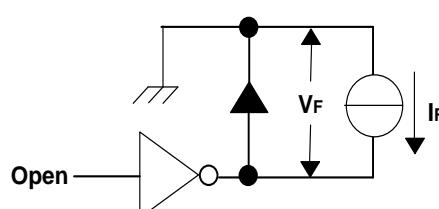


Fig.8 V_F Test Circuit

Parameter Measurement Circuits (Cont.)

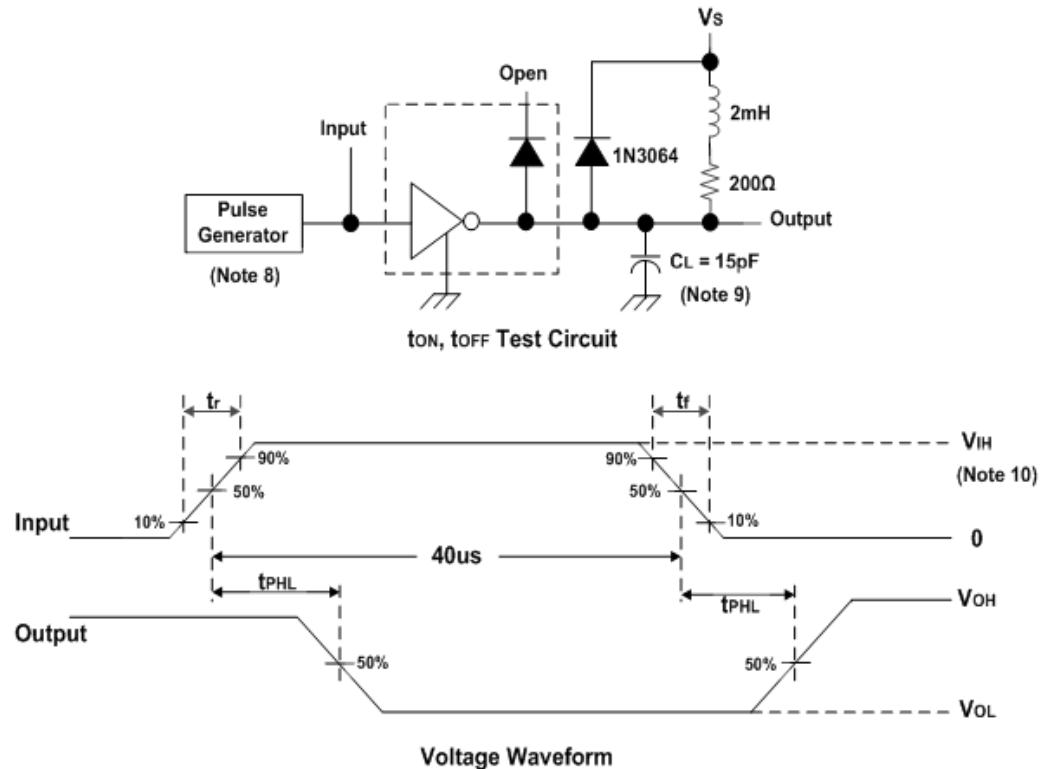
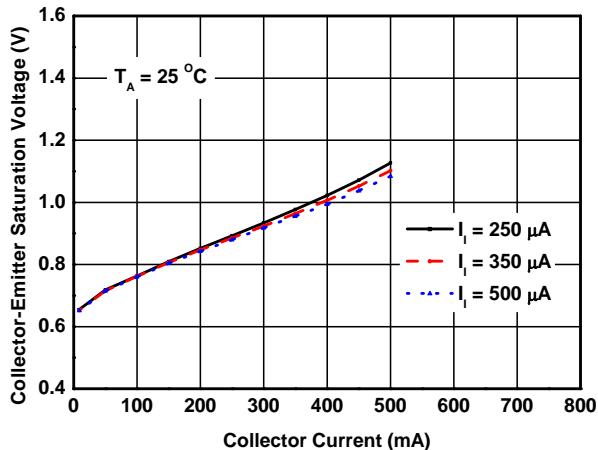


Fig. 9 Latch-Up Test Circuit and Voltage Waveform

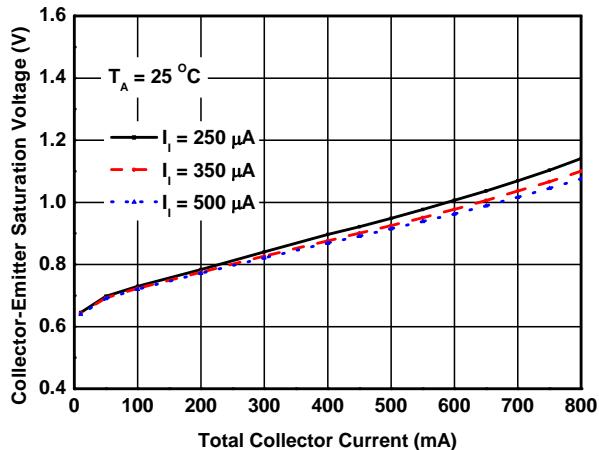
- Notes:
- 8. The pulse generator has the following characteristics: Pulse Width = 12.5Hz, output impedance 50Ω , $t_r \leq 5\text{ns}$, $t_f \leq 10\text{ns}$.
 - 9. C_L includes probe and jig capacitance.
 - 10. For testing the ULN2002A, $V_{IH} = 13\text{V}$; for the ULN2003A, $V_{IH} = 3\text{V}$; for the ULN2004A, $V_{IH} = 8\text{V}$.

Typical Performance Characteristics

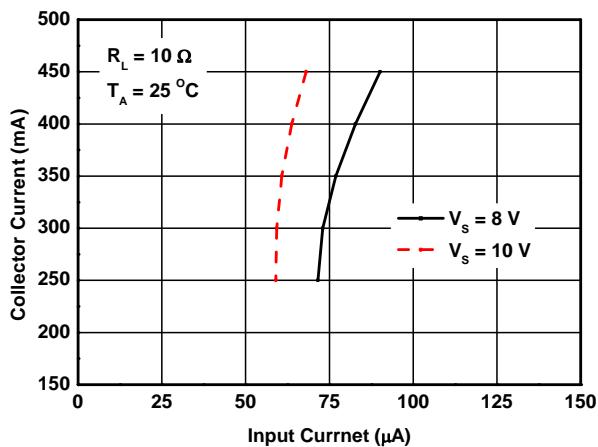
Collector-Emitter Saturation Voltage vs.
Collector Current (One Darlington)



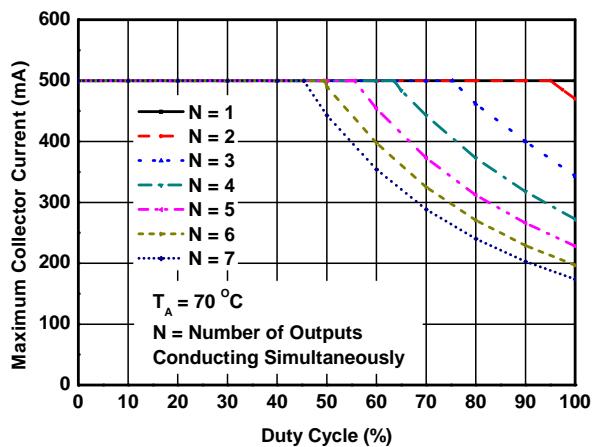
Collector-Emitter Saturation Voltage vs.
Collector Current (Two Darlington in Parallel)



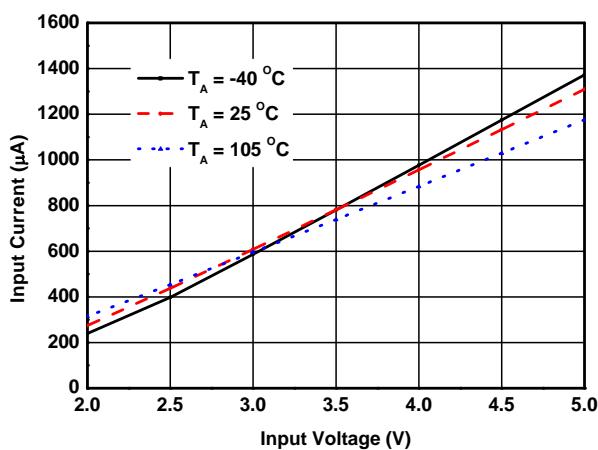
Collector Current vs. Input Current



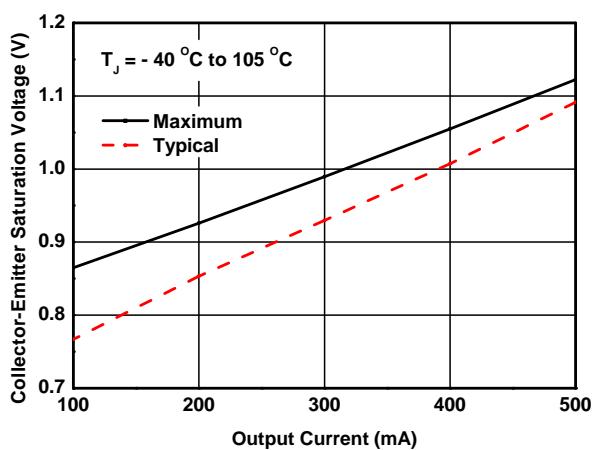
Maximum Collector Current vs. Duty Cycle

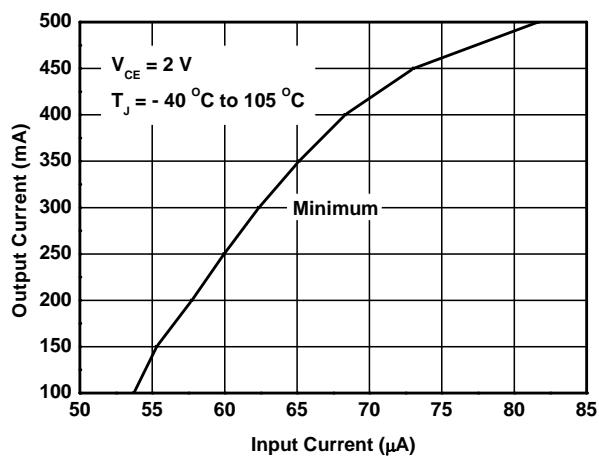


Input Current vs. Input Voltage

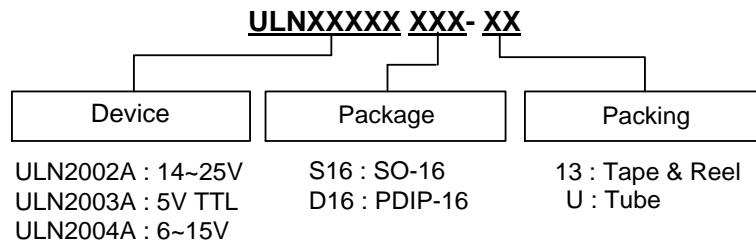


Collector-Emitter Saturation Voltage vs.
Output Current



Typical Performance Characteristics (Cont.)**Output Current vs. Input Current**

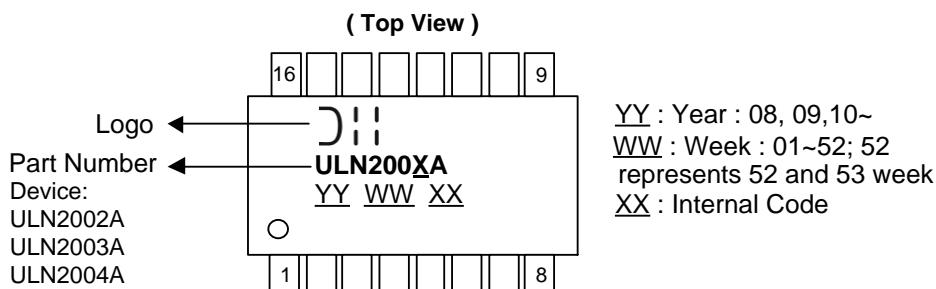
Ordering Information



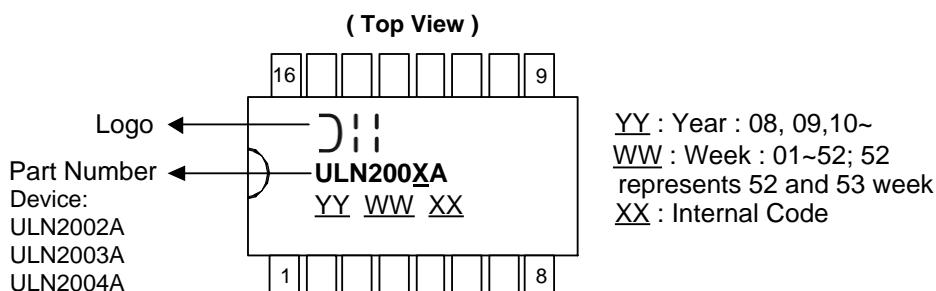
Part Number	Package Code	Package	13" Tape and Reel		Tube	
			Quantity	Part Number Suffix	Quantity	Part Number Suffix
ULN2002AS16-13	S16	SO-16	2,500/Tape & Reel	-13	NA	NA
ULN2003AS16-13	S16	SO-16	2,500/Tape & Reel	-13	NA	NA
ULN2004AS16-13	S16	SO-16	2,500/Tape & Reel	-13	NA	NA
ULN2002AD16-U	D16	PDIP-16	NA	NA	25/Tube	-U
ULN2003AD16-U	D16	PDIP-16	NA	NA	25/Tube	-U
ULN2004AD16-U	D16	PDIP-16	NA	NA	25/Tube	-U

Marking Information

(1) SO-16



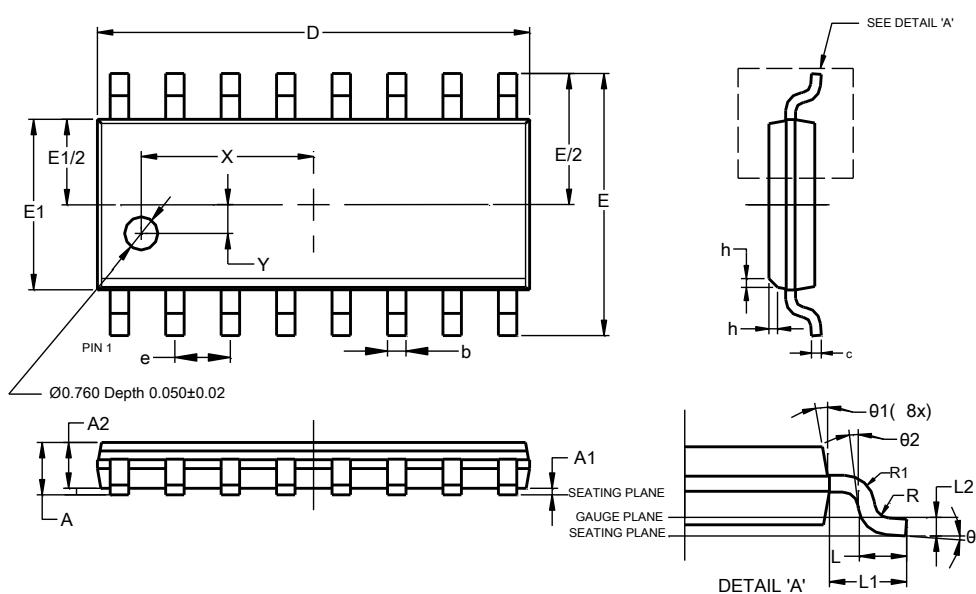
(2) PDIP-16



Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

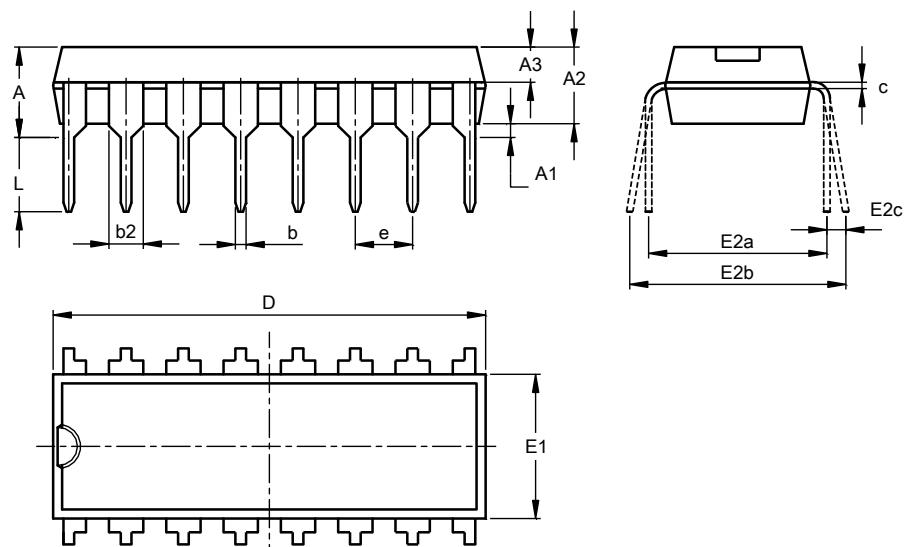
(1) Package Type: SO-16



SO-16			
Dim	Min	Max	Typ
A	--	1.260	--
A1	0.10	0.23	--
A2	1.02	--	--
b	0.31	0.51	--
c	0.10	0.25	--
D	9.80	10.00	--
E	5.90	6.10	--
E1	3.80	4.00	--
e	1.27 BSC		
h	0.15	0.25	0.20
L	0.40	1.27	--
L1	1.04 REF		
L2	0.25 BSC		
R	0.07	--	--
R1	0.07	--	--
X	3.945 REF		
Y	0.661 REF		
θ	0°	8°	--
θ1	5°	15°	--
θ2	0°	--	--

All Dimensions in mm

(2) Package Type: PDIP-16

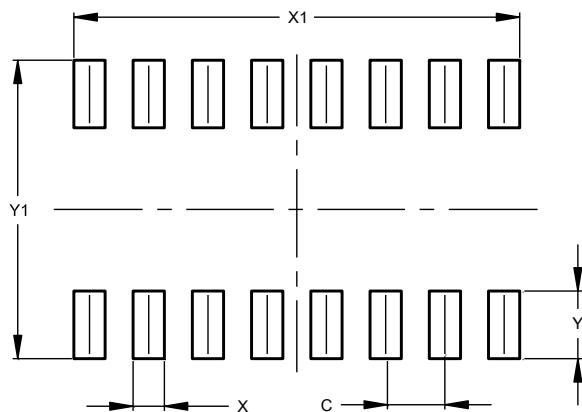


PDIP-16			
Dim	Min	Max	Nom
A	3.60	4.00	3.80
A1	0.51	-	-
A2	3.20	3.40	3.30
A3	1.47	1.57	1.52
b	0.44	0.53	-
b2	1.52BSC		
c	0.25	0.31	-
D	18.90	19.30	19.10
E1	6.15	6.55	6.35
E2a	7.62 BSC		
E2b	7.62	9.30	-
E2c	0.00	0.84	-
e	2.54BSC		
L	3.00	-	-

All Dimensions in mm

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

(1) Package Type: SO-16

Dimensions	Value (in mm)
C	1.270
X	0.670
X1	9.560
Y	1.450
Y1	6.400

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